# CRYSTAL OSCILLATOR SPXO

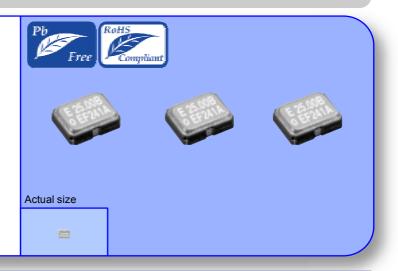
### SG-310 series

•Frequency range : 2 MHz to 48 MHz

•Supply voltage : 1.8 V Typ. / 2.5 V Typ. / 3.3 V Typ. •Current consumption : SEF1.8 V No load condition 48 MHz

1.5 mA Typ.

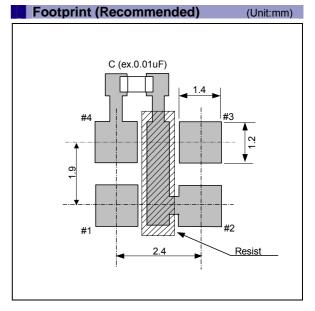
•Function : Standby(s̄T) •Thickness : 1.05 mm Typ.



### Specifications (characteristics)

Item		Symbol	Specifications					Remarks	
			SG-310 SEF	SG-310 SDF	SG-310 SCF	SG-310 SDN	SG-310 SCN	TCITIC	ii No
Output frequency range		<b>f</b> 0	2.000	MHz to 48.000	MHz	3.000 MHz to	48.000 MHz		
Supply voltage		Vcc	1.8 V Typ.	2.5 V Typ.	3.3 V Typ.	2.5 V Typ.	3.3 V Typ.		
			1.6 V to 2.2 V	2.2 V to 3.0 V	2.7 V to 3.6 V	2.2 V to 2.7 V	2.7 V to 3.6 V		
Temperature	Storage temperature	T_stg	-40 °C to +125 °C					Store as bare product after unpacking	
range	Operating temperature	T_use	-40 °C to +85 °C						
Frequency tolerance		F_tol (osc)	B: $\pm 50 \times 10^{-6}$ , C: $\pm 100 \times 10^{-6}$			1		-20 °C to +70 °C	
			M: $\pm 100 \times 10^{-6}$					-40 °C to +85 °C	
			1 1		D:±20 × 10 <sup>-6</sup> ,S:±25 × 10 <sup>-6</sup>		-20 °C to +70 °C	Vcc ±10 %	
					R:±25 × 10 <sup>-6</sup>		-30 °C to +85 °C	VCC ±10 /0	
			_		P:±20 × 10 <sup>-6</sup>		-30 °C to +85 °C	Vcc ±5 %	
					J:±25 × 10 <sup>-6</sup>		-40 °C to +85 °C		
Current consumption		Icc	1.5 mA Max.	1.5 mA Max.	1.5 mA Max.			No load condition, 2 MHz≤fo≤ 4 MHz	
			1.5 mA Max.	1.5 mA Max.			No load condition, 4 MHz <fo≤ 8="" mhz<="" td=""></fo≤>		
			1.5 mA Max.   2.0 mA Max.   2.5 mA Max.		_		No load condition, 8 MHz <fo≤16 mhz<="" td=""></fo≤16>		
			2.0 mA Max.   2.0 mA Max.   2.5 mA Max.				No load condition, 16 MHz <fo≤25 mhz<="" td=""></fo≤25>		
			2.0 mA Max.       2.5 mA Max.       3.5 mA Max.         3.0 mA Max.       3.5 mA Max.       4.5 mA Max.				No load condition, 25 MHz <fo≤33 mhz<="" td=""></fo≤33>		
							No load condition, 33 MHz <fo≤48 mhz<="" td=""></fo≤48>		
			_			4.0 mA Max.	5.0 mA Max.	. No load condition, fo≤48 MHz	
Stand-by current		I_std	0.7 μA Max. (0.2 μA Typ.)	$(0.2 \mu\text{A Typ.}) \mid (0.5 \mu\text{A Typ.}) \mid (1.0 \mu\text{A Typ.}) \mid 1.5 \mu\text{A Max.} \mid 3.0 \mu\text{A Max.} \mid$		ST =GND			
Symmetry		SYM	45 % to 55 % 40 % to 60 % 40 % to 60 % 40 % to 60 %		45 % to 55 %		2 MHz≤fo≤16 MHz	-50 % Vcc level -L CMOS ≤ 15 pF	
							16 MHz <fo≤40 mhz<="" td=""></fo≤40>		
			40 % to 60 %			40 MHz <fo≤48 mhz<="" td=""><td></td></fo≤48>			
High output voltage		Vон	90 % Vcc Min.				IOH=-3 mA		
Low output voltage		Vol	10 % Vcc Max.				IoL= 3 mA		
Output load condition (CMOS)		L_CMOS	15 pF Max.						
Output enable /		VIH	80 % Vcc Min.		70 % Vcc Min.		ST terminal		
disable input voltage		VIL	20 % Vcc Max.		30 % Vcc Max.				
Output rise and fall time		tr/ tf	4 ns Max.				20 % Vcc to 80 % Vcc level, L_CMOS=15 pF		
Oscillation start up time		tosc	10 ms Max.		2 ms Max.		t=0 at 90 % Vcc		
Frequency aging		F_aging	$\pm 5 \times 10^{-6}$ / year Max.		$\pm 3 \times 10^{-6}$ / year Max.		+25 °C, First year, Vcc=1.8 V, 2.5 V, 3.3 V		

#### External dimensions (Unit:mm) #4 $2.5 \pm 0.2$ E25.00B **O EF241A** 0.7 #1 0.9 $.05\pm0.15$ Pin map Connection Pin ST 2 GND 3 OUT 4 Vcc Note. $\overline{\text{ST}}$ pin = HIGH or "open" : Specified frequency output. ST pin = LOW: Output is high impedance, oscillation stops.



### "3D STRATEGY" EPSON TOYOCOM

In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a "3D (three device) strategy" designed to drive both horizontal and vertical growth. We will to grow our three device categories of "Timing Devices", "Sensing Devices" and "Optical Devices", and expand vertical growth through a combination of products from these categories.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers "Digital Convergence" solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.

## PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification. In the future, new group companies will be expected to acquire the certification around the third year of operations.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

### **WORKING FOR HIGH QUALITY**

Epson Toyocom quickly began working to acquire company-wide ISO 9000 series certification, and has acquired ISO 9001 or ISO 9002 certification for all targeted products manufactured in Japanese and overseas plants.

Epson Toyocom has acquired QS-9000 certification, which is of a higher level. Also, TS 16949 certification, which is also of a higher level, has been acquired.

QS-9000 is an enhanced standard for quality assurance systems formulated by leading U.S.automobile manufacturers based on the international ISO 9000 series.

ISO/TS 16949 is a global standard based on QS-9000, a severe standard corresponding to the requirements from the automobile industry.

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  Due to the on-going strategy of gradual unification of part numbers, please review product codes and markings, as they will change during the course of the coming months.
  - We apologize for the inconvenience, but we will eventually have a unified part numbering system for Epson Toyocom that will be user friendly.